Overview

KEMET's PEB228 is an Ultra-High CV Surface-Mount electrolytic capacitor with outstanding electrical performance and high energy storage capability. The device has a polarized all-welded design, tinned copper wire leads, and a negative pole connected to the case. The PEB228's winding is housed in a cylindrical aluminum can, with a high purity aluminum lid and a high quality rubber gasket. The low ESR is the result of a low resistive electrolyte/paper system and an all-welded design. Thanks to its mechanical robustness, the PEB228 is suitable for use in mobile and aircraft installations, with operation up to +150°C. KEMET's automotive grade capacitors meet the demanding Automotive Electronics Council's AEC–Q200 qualification requirements.

Applications

The KEMET PEB228 is a new generation of Ultra-High CV Surface-Mount electrolytic capacitors. It is designed for automotive applications with extremely high demands.

Benefits

- Surface Mount Device
- AEC–Q200 automotive qualified
- 2,000 hours at +150°C
- Ultra-High CV
- Extremely high ripple current
- Up to 21 ARMS ripple current, continuous load
- ESR stability over lifetime
- Polarized all-welded design
- Outstanding electrical performance



Part Number System

PEB228	H	KL	421	0	M	E4
Series	Rated Voltage (VDC)	Size Code	Capacitance Code (µF)	Version	Capacitance Tolerance	Packaging
Radial Crown SMD Aluminum Electrolytic	H = 25 K = 40 M = 63 N = 80	See Dimension Table	The last two digits represent significant figures. The first digit indicates the total number of digits.	0 = Standard	Q = -10 + 30% M = ±20%	E4 = Tray

Performance Characteristics

Item	Performance Characteristics		
Capacitance Range	380 – 4,100 µF		
Rated Voltage	25 – 80 VDC		
Operating Temperature	–40 to +150°C		
Capacitance Tolerance	–10/+30%, (±20% select values) at 100 Hz/+20°C		
Operational Lifetime	W (mm)	Rated voltage, +125°C (hours)	Rated voltage, +150°C (hours)
	17	6,300	1,500
	19	8,400	2,000
Shelf Life	5,000 hours at +105°C or 10 years at +40°C 0 VDC		
Leakage Current	I = 0.003 CV + 4.0 (µA)		
	C = rated capacitance (µF), V = rated voltage (VDC). Voltage applied for 5 minutes at +20°C.		
Vibration Test Specifications	Procedure		Requirements
	1.5 mm displacement amplitude or 5 g maximum acceleration. Vibration applied for three 4-hour sessions at 10 – 2,000 Hz (without clamping).		No leakage of electrolyte or other visible damage. Deviations in capacitance from initial measurements must not exceed: Δ C/C < 5%
Standards	IEC 60384–4 long life grade 40/150/56, AEC-Q200		

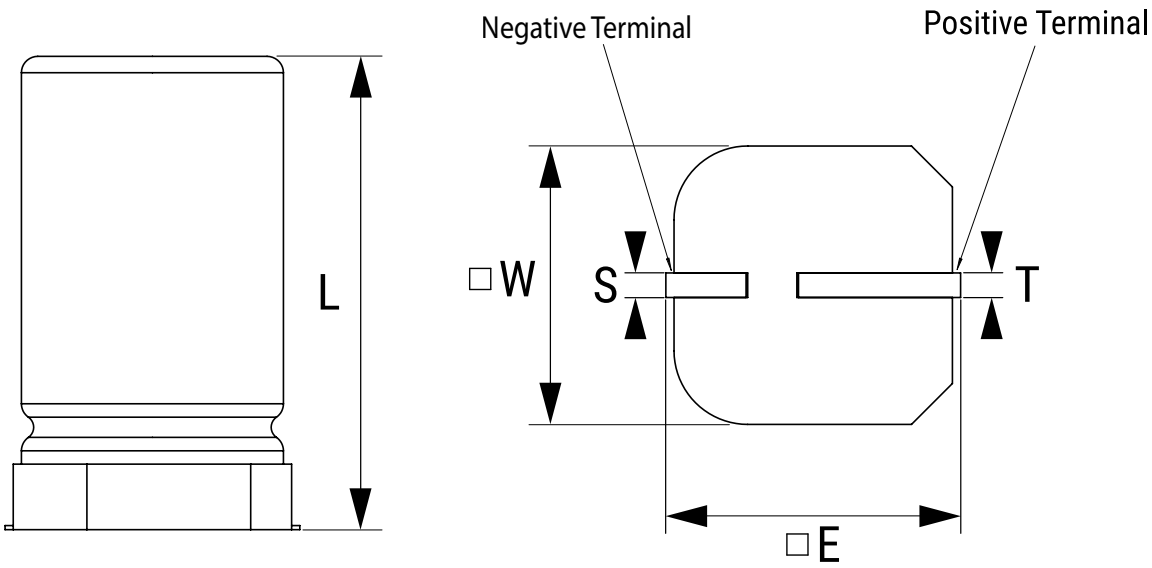
Compensation Factor of Ripple Current (RC) vs. Frequency

Frequency	100 Hz	300 Hz	1 kHz	5 kHz	100 kHz
Coefficient	0.35	0.57	0.80	1.00	1.04

Test Method & Performance

Endurance Life Test	
Conditions	Performance
Temperature	+150°C
Test Duration	1,500 hours (W = 17 mm)
	2,000 hours (W = 19 mm)
Ripple Current	Maximum ripple current specified in table
Voltage	The sum of DC voltage and the peak AC voltage must not exceed the rated voltage of the capacitor
Performance	**The following specifications will be satisfied when the capacitor is tested at +20°C:**
Capacitance Change	Within 15% of the initial value
Equivalent Series Resistance	≤ 2x initial value (typically ≤ 1.3x at 90% of the lifetime)
Leakage Current	Does not exceed leakage current limit

Dimensions – Millimeters



Size Code	Dimensions in mm					Approximate Weight Grams
	W ±0.5	L ±1.0	E ±0.5	S ±0.3	T ±0.3	
KL	17.0	28.9	18.0	1.5	1.5	9.5
KP	17.0	36.9	18.0	1.5	1.5	12.5
LL	19.0	28.9	20.0	1.5	1.5	12.5
LP	19.0	36.9	20.0	1.5	1.5	15.5

Note: Terminal coplanarity ≤ 200 µm

Ordering Options Table

Packaging Kind	Packaging Code
Standard Packaging Option	
Tray	E4

Shelf Life

The capacitance, ESR and impedance of a capacitor will not change significantly after extended storage periods, however, the leakage current will very slowly increase. KEMET products are particularly stable and allow a shelf life in excess of ten years at 40°C. See sectional specification under each product for specific data.

Reliability

Estimated field failure rate: ≤ 0.15 ppm (failures per year/produced number of capacitors per year)
The expected failure rate for this capacitor range is based on field experience for capacitors with structural similarity.

Environmental Compliance

All Part Numbers in this datasheet are Reach and RoHS compliant and Halogen-Free.

As an environmentally conscious company, KEMET is working continuously with improvements concerning the environmental effects of both our capacitors and their production.

In Europe (RoHS Directive) and in some other geographical areas such as China, legislation has been put in place to prevent the use of some hazardous materials, such as lead (Pb), in electronic equipment. All products in this catalog are produced to help our customers' obligations to guarantee their products and fulfill these legislative requirements. The only material of concern in our products has been lead (Pb), which has been removed from all designs to fulfill the requirement of containing less than 0.1% of lead in any homogeneous material.

KEMET will closely follow any changes in legislation world wide and makes any necessary changes in its products, whenever needed. Some customer segments such as medical, military, and automotive electronics may still require the use of lead in electrode coatings. To clarify the situation and distinguish products from each other, a special symbol is used on the packaging labels for RoHS compatible capacitors.

Due to customer requirements, there may appear additional markings such as lead-free (LF) or lead-free wires (LFW) on the label.

Table 1 – Ratings & Part Number Reference

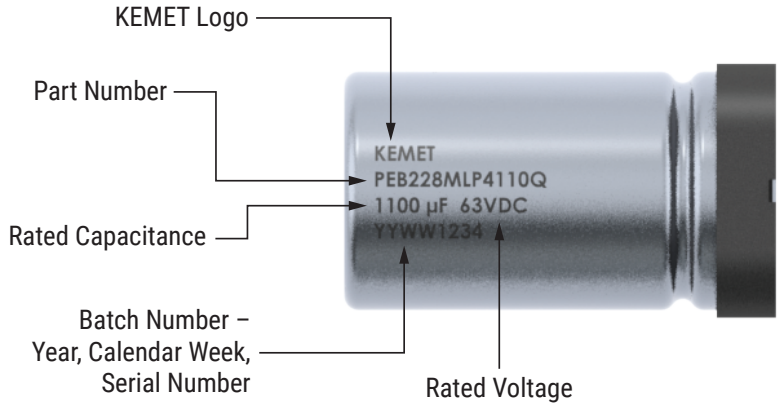
Rated Voltage 125°C	Rated Capacitance	Size Code	Case Size	Ripple Current					ESR			Part Number
				Maximum			Rated	Maximum (Reduced Voltage)	Maximum			
(VDC)	120 Hz 20°C (µF)		W x L (mm)	≥ 5 kHz 125°C (A)[1]	≥ 5 kHz 140°C (A)[2]	≥ 5 kHz 150°C (A)[2]	≥ 5 kHz 125°C (A)[2]	≥ 5 kHz 125°C (A)[3]	100 Hz 20°C (mΩ)	100 kHz 20°C (mΩ)	5–100 kHz 125–150°C (mΩ)	
25	2,100	KL	17 x 29	17.0	10.8	4.8	6.1	7.7	58	32	12.3	PEB228HKL4210ME4
25	3,000	KP	17 x 37	19.1	12.1	5.4	7.3	9.2	41	23	9.8	PEB228HKP4300ME4
25	2,800	LL	19 x 29	19.2	12.1	5.4	6.9	8.8	43	24	10.6	PEB228HLL4280QE4
25	4,100	LP	19 x 37	21.4	13.6	6.1	8.3	10.4	31	18	8.5	PEB228HLP4410QE4
40	1,100	KL	17 x 29	16.5	10.4	4.7	5.9	7.5	79	32	13.1	PEB228KKL4110QE4
40	1,700	KP	17 x 37	18.8	11.9	5.3	7.2	9.0	54	23	10.1	PEB228KKP4170QE4
40	1,700	LL	19 x 29	18.8	11.9	5.3	6.8	8.6	55	24	11.0	PEB228KLL4170QE4
40	2,400	LP	19 x 37	21.1	13.3	6.0	8.2	10.3	39	18	8.8	PEB228KLP4240QE4
63	520	KL	17 x 29	12.7	8.1	3.6	4.6	5.8	133	45	22.0	PEB228MKL3520QE4
63	750	KP	17 x 37	14.8	9.3	4.2	5.6	7.1	93	32	16.4	PEB228MKP3750QE4
63	750	LL	19 x 29	15.0	9.5	4.3	5.4	6.9	94	33	17.3	PEB228MLL3750QE4
63	1,100	LP	19 x 37	17.1	10.8	4.8	6.6	8.4	66	24	13.3	PEB228MLP4110QE4
80	380	KL	17 x 29	12.1	7.7	3.4	4.5	5.6	175	59	24.2	PEB228NKL3380QE4
80	560	KP	17 x 37	13.9	8.8	3.9	5.2	6.4	123	44	18.5	PEB228NKP3560QE4
80	570	LL	19 x 29	14.2	9.0	4.0	5.4	6.7	122	45	19.3	PEB228NLL3570QE4
80	820	LP	19 x 37	16.4	10.3	4.6	6.5	8.1	86	32	14.6	PEB228NLP3820QE4

[1] *Capacitor-mounted with low thermal resistance path (heat-sink).*

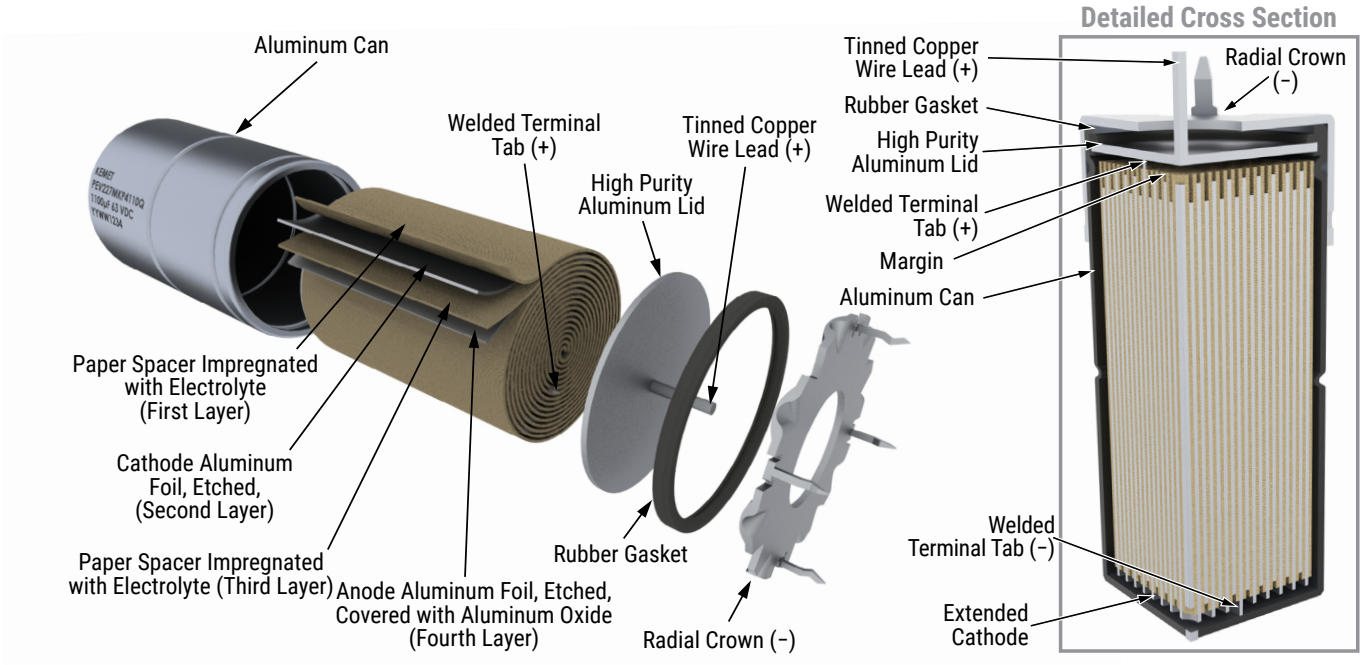
[2] *Continuous operation at Natural Convection (D20 & D18, 4,000h; D16, 3000h)*

[3] *Continuous operation at Natural Convection. Reduced life (D20 & D18, 2000h; D16, 1500h)*

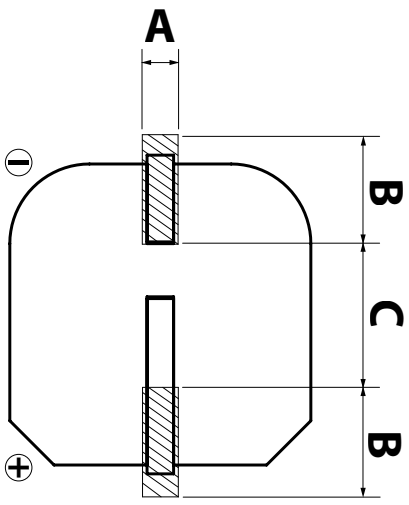
Marking



Construction



Landing Pad – Millimeters



Size Code	A	B	C
KL, KP	7.2	6.5	2.5
LL, LP	7.2	7.5	2.5
Units in mm			

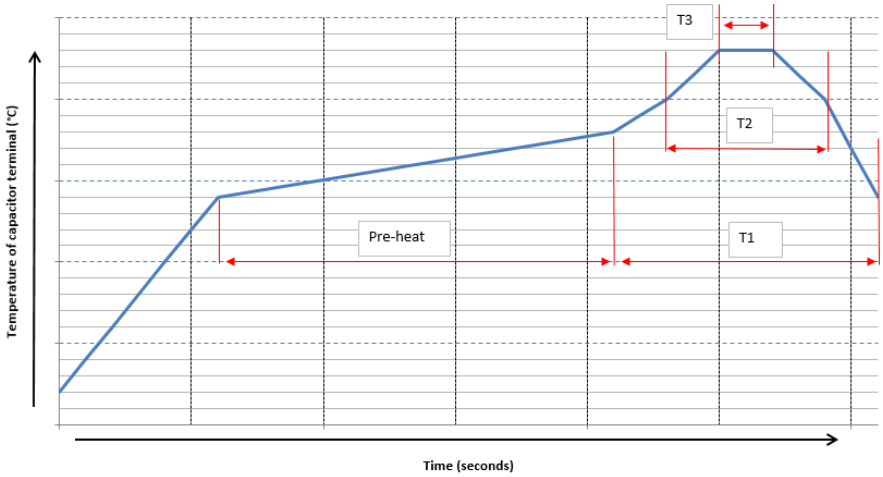
Reflow Soldering

The soldering conditions should be within the specified conditions below:

- Vapor heat transfer systems are not recommended.
- The system should be thermal, such as infra-red radiation or hot blast.
- Observe the soldering conditions as shown below.
- Do not exceed these limits and avoid repeated reflowing.

Time Period	Preheating	T1	T2	T3
Temperature (°C)	150 – 180	≥ 200	≤ 230	≤ 240
Time (seconds)		60 – 180	≤ 40	≤ 20
Reflow can be performed per the above parameters up to 2x				

The described re-flow profile corresponds to AEC Q-200 [condition J] - resistance to soldering heat.



Construction Data

The manufacturing process begins with the anode foil being electrochemically etched to increase the surface area and then "formed" to produce the aluminum oxide layer. Both the anode and cathode foils are then interleaved with absorbent paper and wound into a cylinder. During the winding process, aluminum tabs are attached to each foil to provide the electrical contact.

The winding is assembled to the capacitor Al-can and to the Al-lid. The can is filled with electrolyte and the winding is impregnated during a vacuum treatment. The capacitor is sealed. Throughout the process, all materials inside the housing must be maintained at the highest purity and be compatible with the electrolyte.

Each capacitor is aged and tested before being packed. The purpose of aging is to repair any damage in the oxide layer and thus reduce the leakage current to a very low level. Aging is carried out at elevated temperature and is accomplished by applying voltage to the device while carefully controlling the supply current. The process takes between 2 and 20 hours, depending on voltage rating.

Damage to the oxide layer can occur due to a variety of reasons:

- Slitting of the anode foil after forming
- Attaching the tabs to the anode foil
- Minor mechanical damage caused during winding

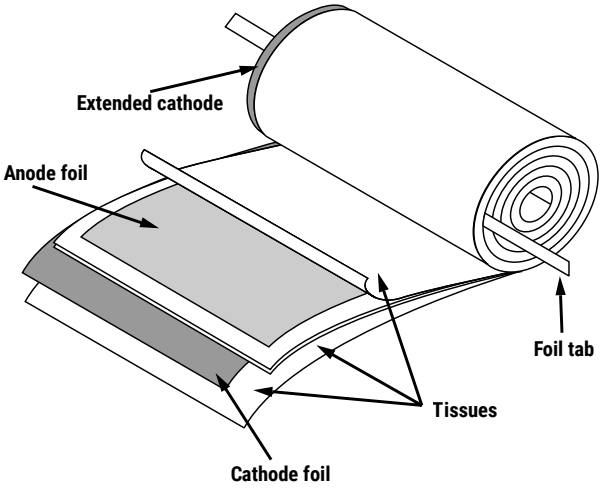
The following tests are applied for each individual capacitor.

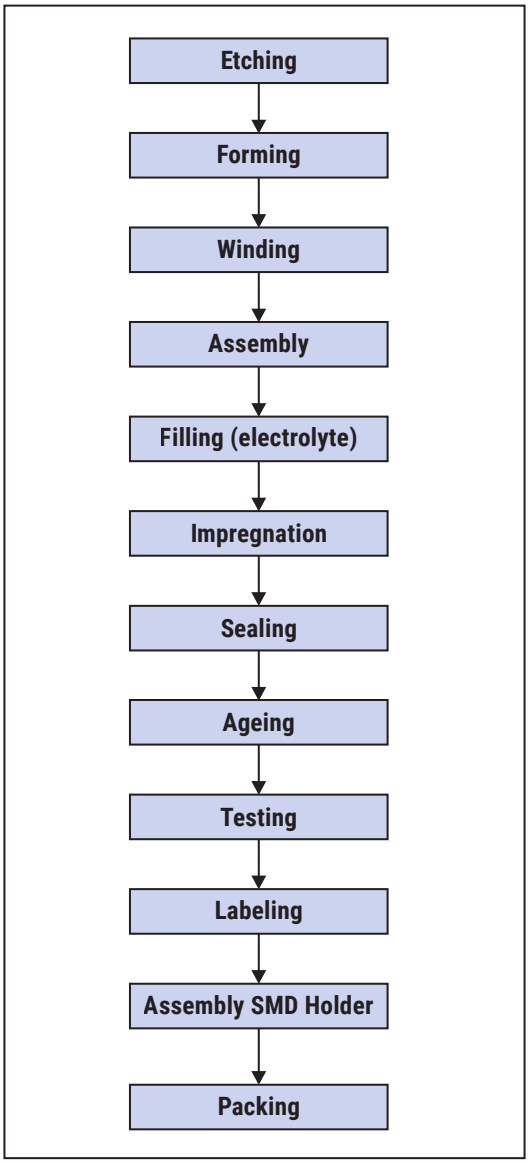
Electrical:

- Leakage current
- Capacitance
- ESR
- Tan Delta

Mechanical/Visual:

- Pull strength test of wire terminals
- Print detail
- Box labels
- Packaging, including packed quantity





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Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product–related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.

KEMET requires its products to be packaged and shipped on pallets. This is because KEMET's products are specifically designed to be packed onto pallets during shipment. If for any reason, the products are removed from pallets by the shipping party and shipped to the end customer, then additional external protection is required. In this instance, an external box with two carton layers and an upwards orientation sticker must be used by the shipping party, with the empty space filled with filling material, and afterwards sealing the box. If this packing and packaging guideline is not followed by the shipping party, the shipping party, and not KEMET, will be held responsible for any packaging, packing and/or product damages upon delivery of the products to the end customer. KEMET hereby disclaims any liability for damages to the products or otherwise that have been, or threaten to be, inflicted, result from or are in any way related to the packaging, packing or damage by the shipping party in contravention of the packing and packaging guidelines herein.

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